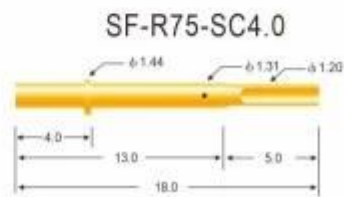
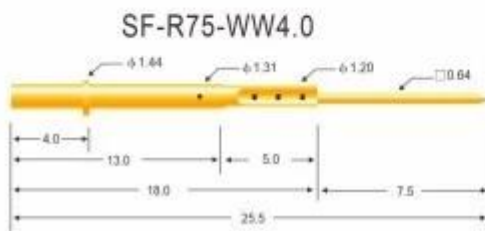
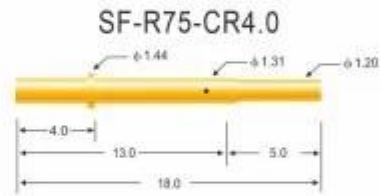
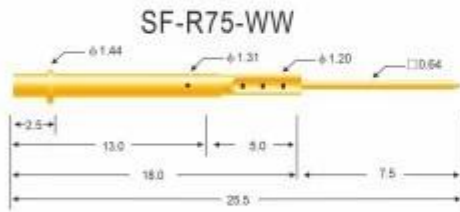
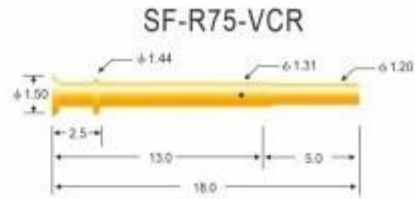
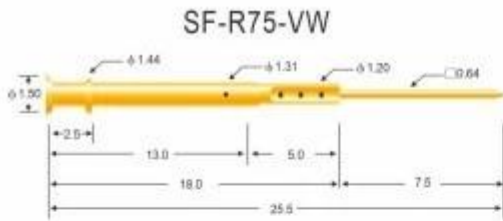


技术规格 PROBE SPECIFICATIONS

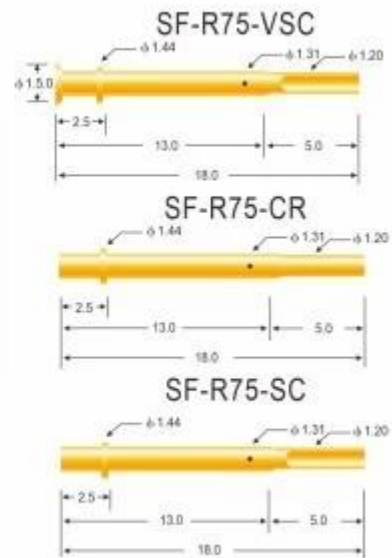
Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Full travel 行程	3.4(.1338 ") / 2.50(.0984 ")
Spring force 弹簧压力	120g(克)
Materials and finishes 材料及涂饰	Plunger: SK4, Ni or Au plated BeCu, Ni or Au plated Barrel: Phosphor bronze, Au plated Spring: Stainless steel
Current rating 额定电流	3A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications
Materials and finishes: Phosphor bronze, Gold plated



技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Full travel 行程	2.5(.0984 ")
Materials and finishes 材料及涂饰	Barrel: Brass, Au plated
Connections 接线形式	Crimp: R75-VCR, R75-CR, R75-CR4.0 Solder cup: R75-VSC, R75-SC, R75-SC4.0 Wire wrap: R75-VW, R75-WW, R75-VW4.0, R75-WW4.0



Receptacle specifications
Materials and finishes: Phosphor bronze, Gold plated



1. 24-pin probe
2. OEM probe
3. Probe
4. Probe



1. PCB ICT FCT
2. 2
3. BGA
4. QZ VZ LM
- 5.
- 6.
7. 30# OK POM



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products



6. Packing



